

L Number	Hits	Search Text	DB	Time stamp
1	30274	(planariz\$5 or polish\$3) with (metal or copper)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/18 08:23
8	25573	(planariz\$5 or polish\$3) with etch\$4	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/18 08:24
15	6082	((planariz\$5 or polish\$3) with (metal or copper)) and ((planariz\$5 or polish\$3) with etch\$4)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/18 08:24
22	1515	((planariz\$5 or polish\$3) with (metal or copper)) and ((planariz\$5 or polish\$3) with etch\$4) and (planariz\$5 with (metal or copper) with etch\$4)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/18 09:40
29	54	((planariz\$5 or polish\$3) with (metal or copper)) and ((planariz\$5 or polish\$3) with etch\$4) and (planariz\$5 with (metal or copper) with etch\$4) and (etch\$4 with (nitric or "HNO.sub.3"))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/18 09:40
36	57	((planariz\$5 or polish\$3) with (metal or copper)) and ((planariz\$5 or polish\$3) with etch\$4) and (planariz\$5 with (metal or copper) with etch\$4) and (etch\$4 with (hydrochloric or "HCl"))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/18 08:29
43	105	((planariz\$5 or polish\$3) with (metal or copper)) and ((planariz\$5 or polish\$3) with etch\$4) and (planariz\$5 with (metal or copper) with etch\$4) and (etch\$4 with (nitric or "HNO.sub.3")) or ((planariz\$5 or polish\$3) with (metal or copper)) and ((planariz\$5 or polish\$3) with etch\$4) and (planariz\$5 with (metal or copper) with etch\$4) and (etch\$4 with (hydrochloric or "HCl"))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/18 08:29
50	181	((planariz\$5 or polish\$3) with (metal or copper)) and ((planariz\$5 or polish\$3) with etch\$4) and (planariz\$5 with (metal or copper) with etch\$4) and (planariz\$5 same (etchant\$1 or gas)) and plasma	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/18 09:50
57	172	((planariz\$5 or polish\$3) with (metal or copper)) and ((planariz\$5 or polish\$3) with etch\$4) and (planariz\$5 with (metal or copper) with etch\$4) and (planariz\$5 same (etchant\$1 or gas)) and plasma) and ((dry adj etch\$3) or (plasma with etch\$3) or (ion adj etch\$3) or RIE)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/18 10:28
64	67	((planariz\$5 or polish\$3) with (metal or copper)) and ((planariz\$5 or polish\$3) with etch\$4) and (planariz\$5 with (metal or copper) with etch\$4) and (planariz\$5 same (etchant\$1 or gas)) and plasma) and ((dry adj etch\$3) or (plasma with etch\$3) or (ion adj etch\$3) or RIE) and (planariz\$5 with (etchant\$1 or gas))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/18 09:52
78	97	((planariz\$5 or polish\$3) with (metal or copper)) and ((planariz\$5 or polish\$3) with etch\$4) and (planariz\$5 with (metal or copper) with etch\$4) and (planariz\$5 same (etchant\$1 or gas)) and plasma) and (planariz\$5 with((dry adj etch\$3) or (plasma with etch\$3) or (ion adj etch\$3) or RIE))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/18 10:29

85	40	<p> ((((planariz\$5 or polish\$3) with (metal or copper)) and ((planariz\$5 or polish\$3) with etch\$4)) and (planariz\$5 with (metal or copper) with etch\$4)) and (planariz\$5 same (etchant\$1 or gas)) and plasma) and (planariz\$5 with((dry adj etch\$3) or (plasma with etch\$3) or (ion adj etch\$3) or RIE))) not ((((((planariz\$5 or polish\$3) with (metal or copper)) and ((planariz\$5 or polish\$3) with etch\$4)) and (planariz\$5 with (metal or copper) with etch\$4)) and (etch\$4 with (nitric or ("HNO.sub.3")))) or (((((planariz\$5 or polish\$3) with (metal or copper)) and ((planariz\$5 or polish\$3) with etch\$4)) and (planariz\$5 with (metal or copper) with etch\$4)) and (etch\$4 with (hydrochloric or "HCl")))) not ((((((planariz\$5 or polish\$3) with (metal or copper)) and ((planariz\$5 or polish\$3) with etch\$4)) and (planariz\$5 with (metal or copper) with etch\$4)) and (planariz\$5 same (etchant\$1 or gas)) and plasma) and ((dry adj etch\$3) or (plasma with etch\$3) or (ion adj etch\$3) or RIE)) and (planariz\$5 with (etchant\$1 or gas))) </p>	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/18 10:30
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L Number	Hits	Search Text	DB	Time stamp
1	439	stray\$2 near4 metal	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/18 15:44
8	20	(stray\$2 near4 metal) and 438/\$7	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/18 15:47
9	12	(stray\$2 near4 metal) and 438/\$7.FS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/18 15:52
16	14	((stray\$2 near4 metal) and 438/\$7) not ((stray\$2 near4 metal) and 438/\$7.FS.)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/18 15:55
23	83	(stray\$2 near4 metal) and (deposit\$3 with metal)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/18 15:56
30	20	((stray\$2 near4 metal) and (deposit\$3 with metal)) and 438/\$7.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/18 15:58
37	9	((stray\$2 near4 metal) and (deposit\$3 with metal)) and 438/\$7.ccls.) not ((stray\$2 near4 metal) and 438/\$7)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/18 15:58